



LOW-VOLTAGE 8:1 MULTIPLEXER/ DEMULTIPLEXER

IDT74CBTLV3251

FEATURES:

- Functionally equivalent to QS3251
- 5Ω bi-directional switch connection between two ports
- Isolation under power-off conditions
- Over-voltage tolerant
- Latch-up performance exceeds 100mA
- $V_{CC} = 2.3V - 3.6V$, Normal Range
- ESD > 2000V per MIL-STD-883, Method 3015;
> 200V using machine model (C = 200pF, R = 0)
- Available in QSOP and TSSOP packages

DESCRIPTION:

The CBTLV3251 is a 1-of-8 high-speed multiplexer/demultiplexer. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The select input (S0, S1, S2) controls the data flow. The multiplexer/demultiplexer switches are disabled when the output-enable (\overline{OE}) input is high.

To ensure that the device is in high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTIONAL BLOCK DIAGRAM

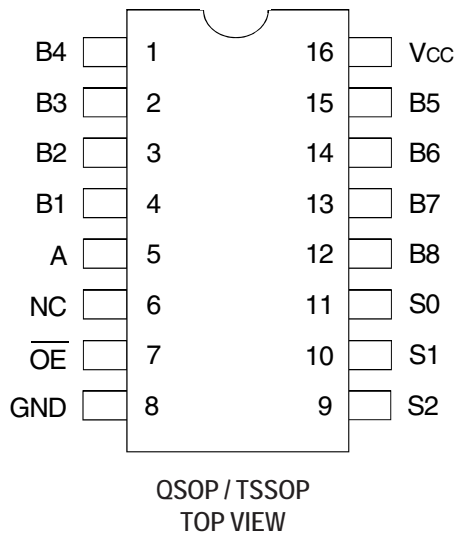


The IDT logo is a registered trademark of Integrated Device Technology, Inc.

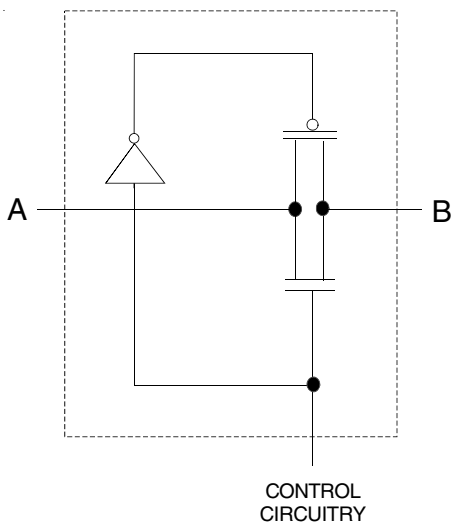
INDUSTRIAL TEMPERATURE RANGE

DECEMBER 2014

PIN CONFIGURATION



SIMPLIFIED SCHEMATIC, EACH SWITCH



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
V _{CC}	Supply Voltage Range	-0.5 to +4.6	V
V _I	Input Voltage Range	-0.5 to +4.6	V
	Continuous Channel Current	128	mA
I _{IK}	Input Clamp Current, V _{I/O} < 0	-50	mA
T _{STG}	Storage Temperature	-65 to +150	°C

NOTE:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

FUNCTION TABLE⁽¹⁾

\overline{OE}	Inputs			Function
	S2	S1	S0	
L	L	L	L	A Port = B1 Port
L	L	L	H	A Port = B2 Port
L	L	H	L	A Port = B3 Port
L	L	H	H	A Port = B4 Port
L	H	L	L	A Port = B5 Port
L	H	L	H	A Port = B6 Port
L	H	H	L	A Port = B7 Port
L	H	H	H	A Port = B8 Port
H	X	X	X	Disconnect

NOTE:

1. H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care

OPERATING CHARACTERISTICS, T_A = 25°C⁽¹⁾

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V _{CC}	Supply Voltage		2.3	3.6	V
V _{IH}	High-Level Control Input Voltage	V _{CC} = 2.3V to 2.7V	1.7	—	V
		V _{CC} = 2.7V to 3.6V	2	—	
V _{IL}	Low-Level Control Input Voltage	V _{CC} = 2.3V to 2.7V	—	0.7	V
		V _{CC} = 2.7V to 3.6V	—	0.8	
T _A	Operating Free-Air Temperature		-40	85	°C

NOTE:

1. All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Conditions: $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

Symbol	Parameter	Test Conditions		Min.	Typ. ⁽¹⁾	Max.	Unit
V_{IK}	Control Inputs, Data Inputs	$V_{CC} = 3V, I_I = -18\text{mA}$		—	—	-1.2	V
I_I	Control Inputs	$V_{CC} = 3.6V, V_I = V_{CC}$ or GND		—	—	± 1	μA
I_{OZ}	Data I/O	$V_{CC} = 3.6V, V_O = 0$ or $3.6V$, switch disabled		—	—	5	μA
I_{OFF}		$V_{CC} = 0, V_I$ or $V_O = 0$ to $3.6V$		—	—	50	μA
I_{CC}		$V_{CC} = 3.6V, I_O = 0, V_I = V_{CC}$ or GND		—	—	10	μA
$\Delta I_{CC}^{(2)}$	Control Inputs	$V_{CC} = 3.6V$, one input at $3V$, other inputs at V_{CC} or GND		—	—	300	μA
C_I	Control Inputs	$V_I = 3V$ or 0		—	4	—	pF
$C_{IO(OFF)}$	A Port	$V_O = 3V$ or $0, \overline{OE} = V_{CC} = 3.3V$		—	40.5	—	pF
	B Port			—	6	—	
$R_{ON}^{(3)}$	$V_{CC} = 2.3V$ Typ. at $V_{CC} = 2.5V$	$V_I = 0$	$I_O = 64\text{mA}$	—	5	8	Ω
			$I_O = 24\text{mA}$	—	5	8	
		$V_I = 1.7V$	$I_O = 15\text{mA}$	—	27	40	
	$V_{CC} = 3V$	$V_I = 0$	$I_O = 64\text{mA}$	—	5	7	
			$I_O = 24\text{mA}$	—	5	7	
		$V_I = 2.4V$	$I_O = 15\text{mA}$	—	10	15	

NOTES:

- Typical values are at $V_{CC} = 3.3V, +25^\circ\text{C}$ ambient.
- The increase in supply current is attributable to each current that is at the specified voltage level rather than V_{CC} or GND.
- This is measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

SWITCHING CHARACTERISTICS

Symbol	Parameter	$V_{CC} = 2.5V \pm 0.2V$		$V_{CC} = 3.3V \pm 0.3V$		Unit
		Min.	Max.	Min.	Max.	
$t_{PD}^{(1)}$	Propagation Delay A to B or B to A	—	0.15	—	0.25	ns
t_{SEL}	Select Time S to A or B	1	4.8	1	4.5	ns
t_{EN}	Enable Time S to B	1	4.8	1	4.5	ns
t_{DIS}	Disable Time S to B	1	5.1	1	5.3	ns
t_{EN}	Output Enable Time \overline{OE} to A or B	1	5	1	4.8	ns
t_{DIS}	Output Disable Time \overline{OE} to A or B	1	5.5	1	6	ns

- NOTE:
- The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance driven by an ideal voltage source (zero output impedance).

TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	V _{CC} ⁽¹⁾ = 3.3V±0.3V	V _{CC} ⁽²⁾ = 2.5V±0.2V	Unit
V _{LOAD}	6	2 x V _{CC}	V
V _{IH}	3	V _{CC}	V
V _T	1.5	V _{CC} / 2	V
V _{LZ}	300	150	mV
V _{HZ}	300	150	mV
C _L	50	30	pF



Test Circuits for All Outputs

DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:

1. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_r ≤ 2.5ns; t_f ≤ 2.5ns.
2. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_r ≤ 2ns; t_f ≤ 2.5ns.

SWITCH POSITION

Test	Switch
t _{PLZ} /t _{PZL}	V _{LOAD}
t _{PHZ} /t _{PZH}	GND
t _{SEL}	Open
t _{PD}	Open

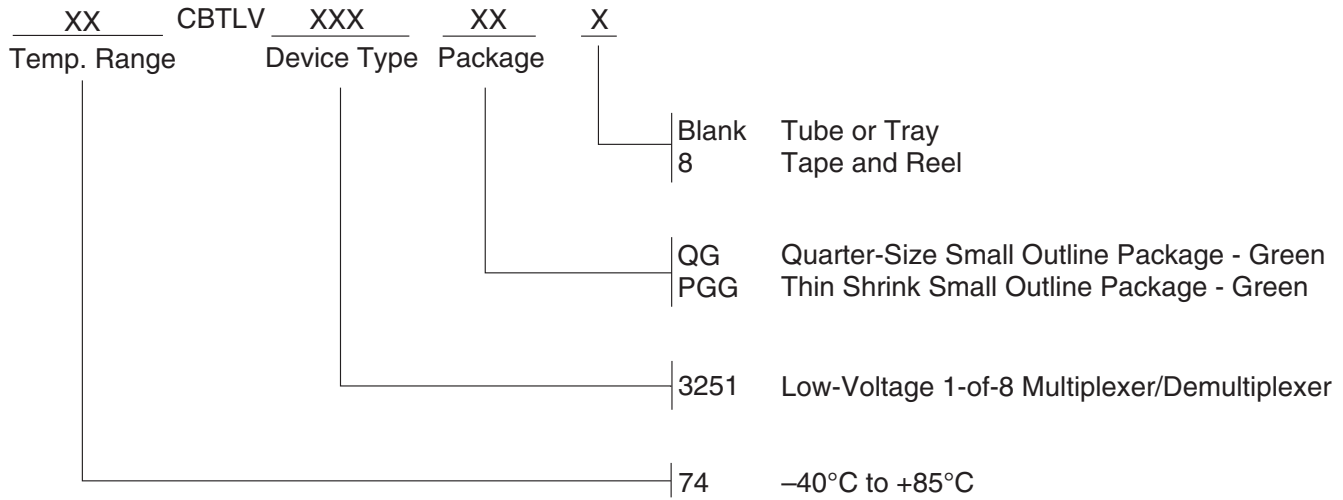


Propagation Delay



Enable and Disable Times

ORDERING INFORMATION



Datasheet Document History

12/18/2014 Pg. 5 Updated the ordering information by removing non RoHS part and adding Tape and Reel information.



CORPORATE HEADQUARTERS
6024 Silver Creek Valley Road
San Jose, CA 95138

for SALES:
800-345-7015 or 408-284-8200
fax: 408-284-2775
www.idt.com

for Tech Support:
logichelp@idt.com

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9